

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Cay- Uwe Pinnow</td><td>09/09/2005</td></tr><tr><td>Thomas Happ</td><td>09/27/2005</td></tr></tbody></table>	Name	Execution Date	Cay- Uwe Pinnow	09/09/2005	Thomas Happ	09/27/2005	
Name	Execution Date						
Cay- Uwe Pinnow	09/09/2005						
Thomas Happ	09/27/2005						
RECEIVING PARTY DATA							
Name:	Infineon Technologies AG						
Street Address:	St.-Martin-Str. 53						
City:	Munich						
State/Country:	GERMANY						
Postal Code:	81669						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11214023</td></tr></tbody></table>	Property Type	Number	Application Number:	11214023			
Property Type	Number						
Application Number:	11214023						
CORRESPONDENCE DATA							
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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ATTORNEY DOCKET NUMBER:	3001.0240C						
NAME OF SUBMITTER:	Andrew J. Aldag						
Total Attachments: 2 source=exe asg 11214023#page1.tif source=exe asg 11214023#page2.tif							

OP \$40.00 11214023

PATENT

500061042

REEL: 016791 FRAME: 0864

ASSIGNMENT

For good and valuable consideration, WE, Cay-Uwe PINNOW, a citizen of Germany, residing at Eggenfeldener Str. 51 81929 München Germany, and Thomas HAPP, a citizen of Germany, residing at 31 Storm Street, Tarrytown NY 10591 USA, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

Reactive Sputtering Process for Optimizing the Thermal
Stability of Thin Chalcogenide Layers

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned

SIGNATURE: _____

Cay-Uwe PINNOW

DATE: _____

09.09.2005

SIGNATURE: _____

Thomas HAPP

DATE: _____

ASSIGNMENT

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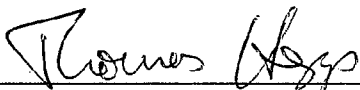
Reactive Sputtering Process for Optimizing the Thermal
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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

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SIGNATURE: _____ DATE: _____
Cay-Uwe PINNOW

SIGNATURE:  _____ DATE: 9/27/05
Thomas HAPP